PREPARED BY:	DATE :		S P E C No. D G - 9 5 4 0 5 1
		SHADD	FILE No.
		SHARP	ISSUE April. 17.1995
APPROVED BY:	DATE:	ELECTRONIC COMPONENTS GROUP	PAGE 1 4 Pages
		SHARP CORPORATION	REPRESENTATIVE DIVISION
			OPTO-ELECTRONIC
		SPECIFICATION	DEVICES DIV.
		DEVICE SPECIFICATION FOR	
		Dot Matrix LED unit	
		MODEL No.	
		LT1550ED	
Please	keep them wit	eets include the contents under the copyrige the reasonable care as important information. Educe them without Sharp's consent.	tht of Sharp Corporation ('Sharp'') Please do not reproduce
2. Please of SHARP	bey the instruction takes no resp	actions mentioned below for actual use of onsibility for damage caused by improper use	this device.
(1) Thi Mai	s device is d in uses of thi	esigned for general electronic equipment. s device are as follows;	
• 0A [ equ	equipment ipment (Termi	• AV equipment • Home appliance • Teleconal) • Weasuring equipment "Tooling ma	communication chine • Computer, etc.
(2)Plea is	se take prope used for the u	r steps in order to maintain reliability and uses mentioned below which require high re	d safety, in case this device eliability.
• Ga	it concerning s leak detecti her safety equ	control and safety of a vehicle (air plane on breaker "Traffic signal • Fire box signment, etc."	, train, automobile etc.) and burglar alarm box
(3) Plea	ase do not us	e for the uses mentioned below which requ	rire extremely high reliability.
• Sp.	ace equipment aclear control	"Telecommunication equipment (Trunk) equipment "Medical equipment etc.	
devices	a SHARP rep for any appl end by SHARP	resentative of sales office in advance when you ications other than those applications for g at (1).	ou intend to use SHARP general electronic equipment
CUST	OMER'S APPROVA	DATE L PRESENT	apr. 17. 1995 ED M Abe

SENTED M. Abe
the artment General Manager of incering Dept., III
-Electronic Devices Div. COM Group RP CORPORATION

MODEL No	),	PAGE
	LT1550ED	1/14

### LT1550ED

### 1. Application

This specification applies to indoor-use Dot Matrix LED unit, LT1550ED.

### 2. Description

This unit is a 16x32dot indoor-use Dot Matrix LED unit which is capable of 3-color display, red(GaAsP/Gap chip), yellow-green(GaP chip), and orange (by mixing the first two).

This unit has shift registers, latch circuits, LED driver ICS and scanning line select circuits built in it, and provides colorful displays using LINE AT A TIME DRIVE METHOD. (LEDs are lit by dynamic lighting method.)

Due to the built-in luminance adjustment circuit, this unit contributes to unify the luminance on a large display board.

3. Outline dimensions and pin configuration	See Page 2/14
4. Ratings and electro-optical characteristics	See Page 3~4/14
5. Terminal functions	See Page 5/14
6. Internal block diagram	See Page 6/14
7. Timing chart	See Page 7/14
8. Reliability test standard	See Page 8/14
9. Incoming inspection standard	See Page 9-11/14
10. Packing specification	See Page 12/14
11. Notes	See Page 1314/14

MODEL	No.		PAGE
		LT1550ED	3/13

### 4. Ratings and electro-optical characteristics

### 4-1. Absolute Maximum Ratings

Ta=25°C

Parameter	Symbol	Rating	Unit	Remark
IC supply voltage	Vcc	-0.3 to +5.5		
LED supply voltage	VLED -	0.3 to +4.5	V	
Input voltage				
(CLOCK, ENABLE, LATCH	v,	-0.3 to $+5.5$	V	
A <sub>0</sub> ~A <sub>3</sub> , RDATA, GDATA)				
Current dissipation ILED		4.5	A	LED's current dissipation
LED on time ton		1	ms I	at 1/16 duty
Operating temperature Topi		-10 to +60	Ç	at lighting rate:25% (1)
Storage temperature	-20 to +70	$\mathbb{C}$		
Lighting rate(*)	tavg	50	%	both red and yellow-green

<sup>(1)</sup> Average lighting rate in five minutes.

### 4-2. Electrical characteristics

Ta=25°, Vcc=5.0V, VLED=4.0V

		Rating				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
IC supply voltage	VCC	4.75	5.0	5. 25	V	
LED supply voltage	VLED	3. 75	4.0	4. 25	V	
IC current dissipation	Icc		140	200	m A	lit up all dots
LED current dissipation	ILED		3.8	4.2	Α	lit up all dots
	ViL	-	-	1.5	V	
Input voltage(l)	<b>У</b> 1 Н	3.5	-	-	V	
	IIL	-	-	0. 12	m A	
Input current(1)	Ітн	-	-	0.1	μΑ	
Clock frequency	fCLK	-	-	10	МНz	

<sup>(1)</sup> It depends on IC's characteristics using at I/O part.

1	MODEL No.	PAGE
	LT1550ED	4/14

### 4-3. Optical characteristics

Ta=25 $^{\circ}$ , Vcc=5. OV,  $V_{LED}$ =4.0 $^{\circ}$ 

		Rating					
Parameter	symbol	Min.	Тур.	Max.	Unit	Remark	
	Red		-	120	-	$cd/m^2$	Adjustable
Luminance	Yellow-green	Lv	-	180	-	$cd/m^2$	Adjustable
Peak emission	Red			635	-	nm	
wavelength	Yellow-green	λP	-	565	-	nm	
Spectrum radiation	Red		-	35	=	nm	
bandwidth	Yellow-green	Δλ	1	30	-	nm	

Condition 1) Ta=25 $^{\circ}$ ,  $V_{cc}$ =5. 0 $^{\circ}$ ,  $V_{LED}$ =4. 0 $^{\circ}$ 

- 2) The luminance immediately after turning on.
- 3) Tolerance =  $\pm 10 \%$
- 4) Each luminance of red and yellow-green can be adjusted with a variable resistor in the circuit. Before delivering the luminance is set to approximately 120cd/m² of red and 180cd/m² of yellow-green.

If necessary to adjust, the luminance can be adjusted by means of VR1 (for red) and VR2(for yellow-green) on the PWB.

# **5.** Terminal functions **5-1.** Power supply (Connector 1)

11 7				
Name	Functions		•	
VLED	For LED	+4V		
Vcc	For IC	+5 <b>Y</b>		
GND	Ground			

### 5-2. Input signal (Connector 2)

Name	Functions
$A_0 - A_3$	Address specification signal for row driver. (See Table 1)
RDATA	Serial signal of display data. ("H"=on, "L"=off)
GDATA	Shifts from right to left in unit. (direction of $V_{D31} \rightarrow V_{D0}$ )
	Latch signal for the contents of shift register.
LATCH	"H": Serial data → parallel data.
	"L": The contents are latched.
	Output enable for LEDs.
ENABLE	"H": LEDs are all off.
	"L": LEDs are lit by data.
CLOCK	Clock signal for data transmission in the shift register.
	"L"→"H": The data are shifted.
GND	Ground for signal. ( Connected to ground in unit.)

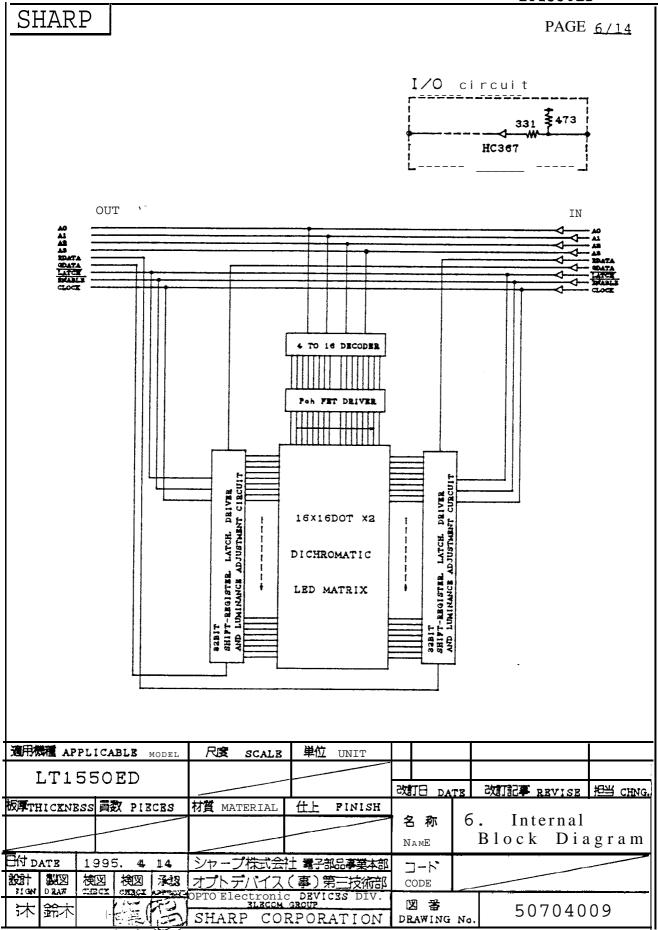
### **5-3.** Output signal (Connector **3)**

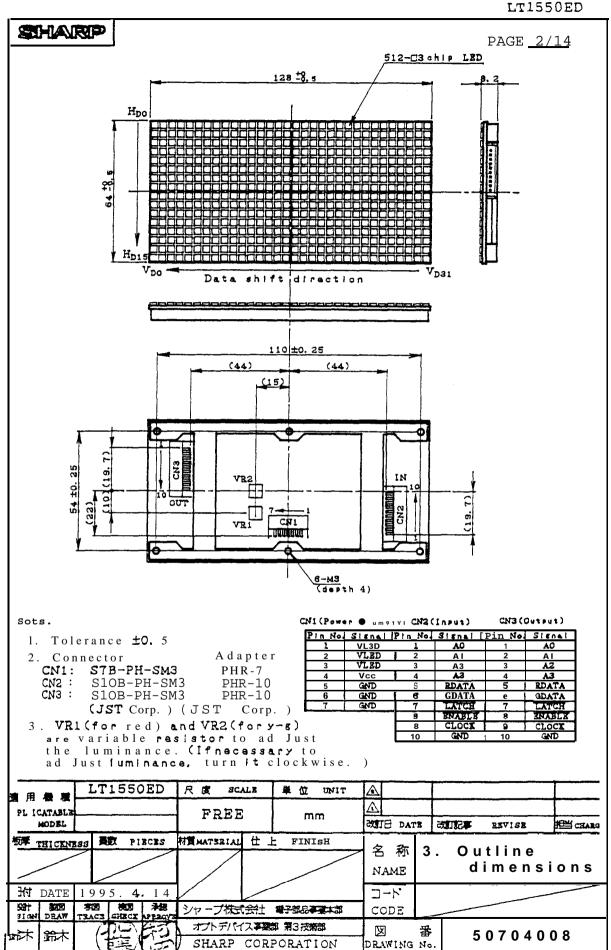
	· ·					
Name	Functions					
$A_0 \sim A_3$	Buffered the input signals $A_0 \sim A_3$ .					
RDATA	Input signal is generated through 32-bit shift register					
GDATA	in the unit.					
LATCH	Buffered the input signal LATCH.					
ENABLE	Buffered the input signal ENABLE.					
CLOCK	Buffered the input signal CLOCK.					
GND1	[Ground for signal. ( Connected to ground for IC in unit.)					

The output signals are transfered to the next unit and utilized as the input signals.

Table 1 ADDRESS(A<sub>0</sub>~A<sub>3</sub>) SET

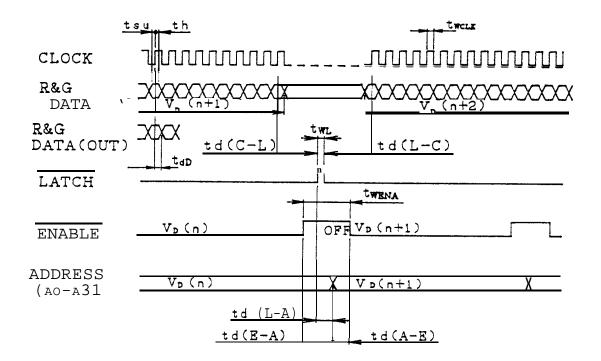
A 2	A 1	Αo	A	3
			0	1
0	0	0	Hdo	H <sub>D8</sub>
0	0	1	$H_{D1}$	Ноя
0	1	0	H <sub>D2</sub>	H <sub>D10</sub>
0	1	1	Н 🛮 з	$H_{D11}$
1	0	0	H <sub>□4</sub>	$H_{D12}$
1	0	1	H D 5	H <sub>D13</sub>
1	1	0	Н 🛚 6	H <sub>D14</sub>
1	1	1	H D 7	H <sub>D15</sub>





PAGE <u>7/14</u>

### 7. Timing Chart



Recommendatory	timing o	conditi	o n		Ta=2	25°C Vcc=5. Ov
			Ratins	1		
Parameter	Symbol	Min.	T Y P.	Max.	Unit	Remarks
Cloak pulse width	t WCLK	50	-	-	n s	
Latchpulse width	t WL	100			n s	
Bnable Pulse width	t W8NA	4			u s	
Data setup time	t s u	60			n s	
Data hold time	t h	20			n s	
Clock-Latch time	td(C-L)	100	-		ns	
Latch-Clock time	td(L-C)	100			n s	
Enable-Address time	td (E-A)	2	-	1	μs	
Address-Enable time	td (A-E)	2	-	-	μs	
Latch-Address time	td (L-A)	0	-	ſ	μs	
1/0 delaytime	tplH. tpHL	-	24	-	n s	e xceptdataterminal
Data delay time	t dD		104	-	n s	RDATA GDATA
Plame frequency	<sup>§</sup> ?R	70	250	1000	Hz	
Enable frequency	fena			16	kHz	

MODEL No.	PAGE
LT1550ED	8/14

### 8. Reliability test standard

### 8-1. Test item and condition

No.	test	condition	Sample	Defective
1	Mechanical shock	1000m/s <sup>2</sup> ;6ms;3times/X, Y,Z	5	0
2	Vibration	1. 5mm; 10~55 Hz/lmin; 2h/X, Y, Z	5	0
3	Temperature cycling	-20℃(60min)~70 ℃(60min);10times	5	0
4	Humidity (steady state	e) Ta= 40° 90%RH; t=500h	5	0
5	High temp. storage	Ta= 70t; t=500h	5	0
6	Low temp. storage	Ta=-20t; t=500h	5	0
7	Operation life	Ta=25°; V <sub>LED</sub> =4V, Vcc=5V; t=500	)h 5	0

### 8-2. Failure criterion

No.	Parameter	symbol	Acceptance limit
1	IC current dissipation	Icc	MAX. U. S.L.x1.2
2	LED current dissipation	ILED	MAX. U. S.L.x1.2
3   1	Luminance	Lv	MIN. Initial value x 0.5
4   Operating check			No defect

<sup>\*</sup> Parameter condition is based on specification.

 $<sup>\</sup>boldsymbol{\mathtt{\#}}$  U. S.L. is Upper Specification L: init.

MODEL No.	PAGE
LT1550ED	9/14

### 9. Incoming inspection standard

### 9-1. Methodof incoming inspection

Unless otherwise agreed in writing, method of incoming inspection shall be in accordance with a sampling inspection based on MIL-STD-105D.

### 9-2. Method of sampling inspection

(a) sampling table : table in MIL-STD-105D

(b) sampling type : single sampling(c) inspection type : normal inspection

(d) inspection level : level II

### 9-3. Acceptable Quality Level("AQL")

(a) Major defects : AQL 0.1%
(b) Minor defects : AQL 0.4%
(c) Slight defects : AQL 2.5%

### 9-4. Inspection item, judgement standard, and defect type

No.	inspection items	judgement standard	defect type
1	Open circuit	(1) Internally opened LED	Major defect
		LED completely remains off.	
		(2) Open copper conductor	
		LED completely remains off.	
2	Short circuit	(1) Internally shorted LED	Major defect
		LED completely remains off or	
		lights unusually.	
		(2) Shorted copper conductor	
		LED completely remains off or	
		lights unusually.	
3	Soldering errors	(1) Short by solder	Major defect
		LED completely remains off or	
		lights unusually.	
		(2) Soldering open	
		LED completely remains offor	
		lights unusually.	

MODEL No.	PAGE
LT1550ED	10/14

No.	inspection item	judgement standard	defect typ
4	Wrong LED type	Emission color is different.	Major def
5	Marking errors	Lot number is not printed.	Major def
6	Dimensions-	Dimensions exceed specified value,	Minor def
7	Characteristics	Electrical characteristics or luminance does not satisfy the specified value.	Minor def
8	Gap of LED's position	1	Minor def
9	Revolution of LED	15" or more : NG	Minor def
10	Protrusion of bond	As a result of protrusion, outline dimensions do not satisfy the specified value.	Minor def
11	Soldering errors	<ol> <li>Insufficient solder or voids in solder.         The amount of solder is too small to completely cover up the copper conductor, or solder has voids.     </li> <li>Solder splash         Solder drops or chips are scattered on the PWB surface.     </li> </ol>	Slight de

\* PWB : Printed Wiring Board

Ì	MODEL No.	PAGE	
	LT1550ED	11/14	

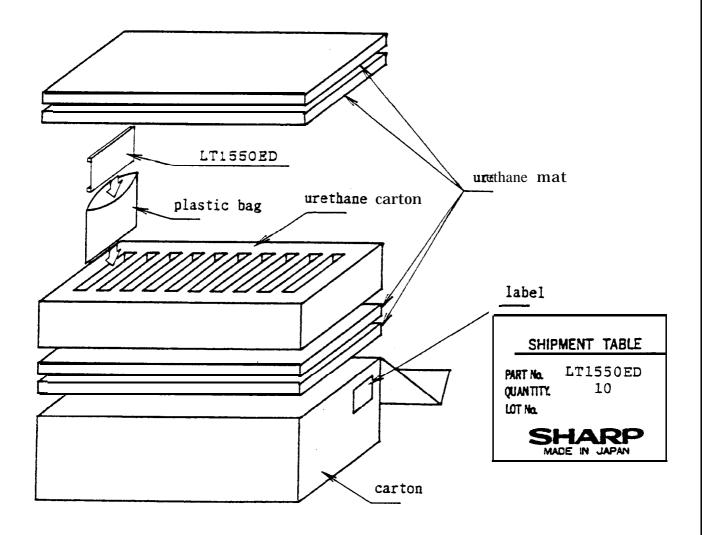
No.	inspection item	judgement standard	defect type
12	Uneven brightness	More than one dot is dimmer than the	Slight defect
		other dots (for the same color).	:
		Judged by limited sample.	
13	Dust	0.6mmø or more	Slight defect
	٠~	(dust in lamp which can be recognized	
		through resin)	
14	Marking errors	Lot number is blurred or spotted by	Slight defect
		ink.	

MODEL	N o .	PAGE
	LT1550ED	12/14

### 10. Packing specification

- 1) One(1) LED unit is packed in a conductive plast c bag.
- 2) Ten(IO) LED units are put into a carton.

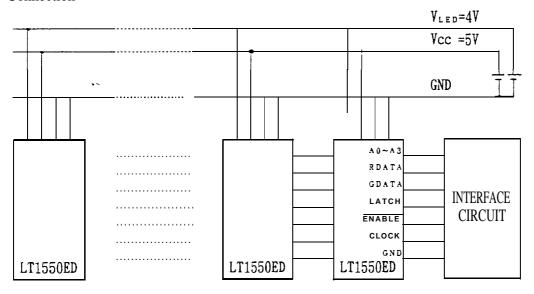
  The label is filled out the model No., quantity, lot No.
- 3) For quantities less than ten(10) LED units per carton, the packing form may differ from the one given in these specifications.



į	MODEL No.	PAGE
	LT1550ED	13/14

### 11. Notes

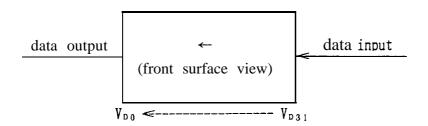
### 11-1. Connection



Io minimize noise, observe the following instruction;

- O Minimize the connection between a power supply and a unit.
  - ( Use wire as thick and short as possible for power inc. )
- O Any 1/0 signal lines must be 15cm or less long.

### 11-2. Direction of data shift



Shift from right to left in unit. (direction of  $V_{D31} \rightarrow V_{D0}$ )

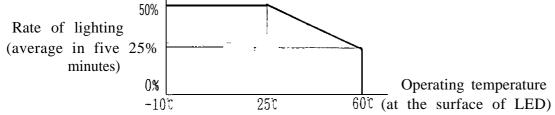
MODEL No.	PAGE
LT1550ED	14/14

#### 11-3. Precaut ons on installing

- 1) Weight: Approx. 70 grams per unit.
- 2) When fixing the LED unit to its mounting base, use screw holes at its back side. (torque: 0.4 ~ 0.5N·m or less)
  - And when using more than two(2) PCS. of LED units in a display board, they should be mounted at more than 128mm(parallel direction), 64mm(vertical direction) pitch between each LED unit.
- 3) When using a-lot of LED units in a same display board, take adequate cooling measures such as a ventilation fan, so the surface temperature of any unit does not exceed 60°C. So the mounting base should be made from a thermally well conductive material.
- 4) The mounting base should be designed so that it does not cover up the area of the unit's back where ICS are located.
- 5) The LED unit includes CMOS devices. When handling, take adequate electrostatic preventive measures.
- 6) Please do not use the LED units under a high temperature and a high percentage of humidity condition. And protect the units from direct exposure to dust, dirt, salty air, S0, gas, or other corrosive gases.
- 7) This unit does not have waterproof structure.
- 8) When fixing the LED unit to its mounting base, take adequate isolated preventive measures.
- 9) Cleaning is not allowed. When it is needed, please wipe with a dry clo h.
- 10) Exercise care not to give the unit a hard jolt from accidental drop or any other cause as it will cause permanent deformation. And do not scrub LED's edge or surface, so it will cause destruction of LED lamps.

#### 11-4. Other precautions

- 1) In an ambience with extremely high EMI, the unit may malfunction.
- 2) While adjusting the luminance, please use a screw driver suited for holes of the variable resistor. And please minimize to added pressure with a screw driver when adjusting. (1ON or less)
- 3) If an address  $signal(A_0 \sim A_3)$  stops, LED may break.
- 4) The luminance of LED gradually decrease for lighting, and lighting specific LED for a long time, it causes deterioration of lighting quality. Therefore please contrive to light all LED dots uniformly with display data.
- 5) The rate of lighting derating curve is the following. Please be careful not to exeed the lighting ratio, as LED may be damaged or degraded by temperature rise, when it is exeeded.



RECORDS OF REVISION

MODEL No.

LT1550ED

DOC. FIRST ISSUE

April. 17. 1995

IDENT. DATA No.

IDENT. DATA No.					
DATE	REF. PAGE PARAGRAPH DRAWING No.	REVISED	SUMMARY	CHECK & APPROVAL	
<b>1</b> 995. 4.17	DRAWING NO.		- establish - (DG-954051)		